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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q68281

Hui ZHONG, et al.

Appln. No.: 10/049,270

Group Art Unit: 2811

Confirmation No.: 9445

Examiner: Tuan T. Dinh

Filed: February 11, 2002

For: MULTILAYERED PRINTED CIRCUIT BOARD, SOLDER RESIST COMPOSITION,
MULTILAYERED PRINTED CIRCUIT BOARD MANUFACTURING METHOD, AND
SEMICONDUCTOR DEVICE

AMENDMENT UNDER 37 C.F.R. § 1.111

MAIL STOP AMENDMENT

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

This Amendment is in response to the Office Action dated September 9, 2005, in which the Examiner set forth a three-month period for response, making a response timely if filed on or before December 9, 2005. Please amend the above-identified application as follows: